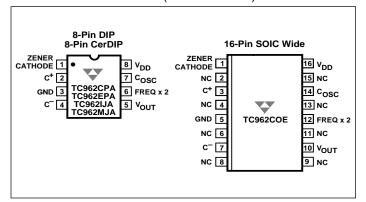




#### **FEATURES**

- No External Diodes Required
- Wide Operating Range ......3V to 18V
- No Low Voltage Terminal Required
- Application Zener On Chip
- OSC Frequency Doubling Pin Option for Smaller Output Capacitors

### PIN CONFIGURATIONS (DIP and SOIC)



#### **GENERAL DESCRIPTION**

The TC962 is an advanced version of the industrystandard 7662 high-voltage DC-to-DC converter. Using improved design techniques and CMOS construction, the TC962 can source as much as 8mA versus the 7662's 20mA capability.

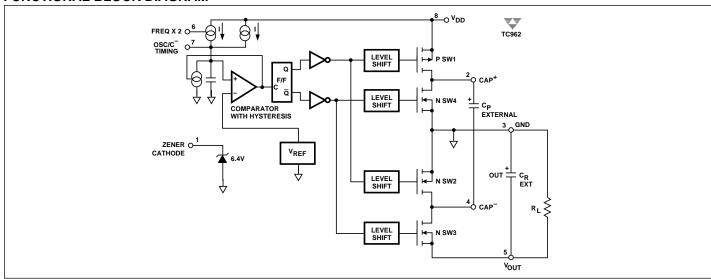
As an inverter, the TC962 can put out voltages as high as 18V and as low as 3V without the need for external diodes. The output impedance of the device is a low  $28\Omega$  (with the proper capacitors), voltage conversion efficiency is 99.9%, and power conversion efficiency is 97%.

The low voltage terminal (pin 6) required in some 7662 applications has been eliminated. Grounding this terminal will double the oscillator frequency from 12kHz to 24kHz. This will allow the use of smaller capacitors for the same output current and ripple, in most applications. Only two external capacitors are required for inverter applications. In the event an external clock is needed to drive the TC962 (such as paralleling), driving this pin directly will cause the internal oscillator to sync to the external clock.

#### ORDERING INFORMATION

Part No.	Package	Temp. Range			
TC962COE	16-Pin SOIC Wide	0°C to +70°C			
TC962CPA	8-Pin Plastic DIP	0°C to +70°C			
TC962EPA	8-Pin Plastic DIP	- 40°C to +85°C			
TC962IJA	8-Pin CerDIP	– 25°C to +85°C			
TC962MJA	8-Pin CerDIP	– 55°C to +125°C			
TC7660EV	Evaluation Kit for Charge Pump Family				

### **FUNCTIONAL BLOCK DIAGRAM**



## **TC962**

Pin 1, which is used as a test pin on the 7662, is a voltage reference zener on the TC962. This zener (6.4V at 5 mA) has a dynamic impedance of  $12\Omega$  and is intended for use where the TC962 is supplying current to external regulator circuitry and a reference is needed for the regulator circuit. (See applications section.)

The TC962 is compatible with the LTC1044, SI7661, and ICL7662. It should be used in designs that require greater power and/or less input to output voltage drop. It offers superior performance over the ICL7660S.

## **ABSOLUTE MAXIMUM RATINGS\***

Supply Voltage ( $V_{DD}$ to GND)+18V Input Voltage Any Pin( $V_{DD}$ + 0.3) to ( $V_{SS}$ – 0.3)
Current Into Any Pin10mA
ESD Protection ±2000V
Output Short Circuit Continuous (at 5.5V Input)
Storage Temperature Range – 65°C to +150°C
Lead Temperature (Soldering, 10 sec)+300°C
Operating Temperature Range
CPA, COE0°C to +70°C
IJA – 25°C to +85°C
EPA – 40°C to +85°C
MJA – 55°C to +125°C

Package Power Dissipation	
SOIC	760mW
PDIP	730mW
CerDIP	800mW
Package Thermal Resistance	
CerDIP, R <sub>0J-A</sub>	90°C/W
PDIP, R <sub>0J-A</sub>	140°C/W

\*Static-sensitive device. Unused devices must be stored in conductive material. Protect devices from static discharge and static fields. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to Absolute Maximum Rating Conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS:** $V_{DD} = 15V$ , $T_A = +25^{\circ}C$ (See Test Circuit), unless otherwise indicated.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
$\overline{V_{DD}}$	Supply Voltage		3		18	V
I <sub>S</sub>	Supply Current V <sub>DD</sub> = 15V	$R_{L} = \infty$ $T_{A} = +25^{\circ}C$ $0 \le T_{A} \le +70^{\circ}C$	_	510 560	_ 700	_ μA
	$V_{DD} = 5V$	$-55 \le T_A \le +70^{\circ}C$ $-55 \le T_A \le +125^{\circ}C$ $T_A = +25^{\circ}C$ $0 \le T_A < +70^{\circ}C$ $-55 \le T_A \le +125^{\circ}C$		650 190 210 210		μΑ μΑ μΑ μΑ μΑ
R <sub>O</sub>	Output Source Resistance	$I_L = 20$ mA, $V_{DD} = 15$ V $I_L = 80$ mA, $V_{DD} = 15$ V $I_L = 3$ mA, $V_{DD} = 5$ V	_	32 35 —	37 40 50	Ω Ω Ω
C <sub>OSC</sub>	Oscillator Frequency	Pin 6 Open Pin 6 GND	_	12 24	_	kHz kHz
P <sub>EFF</sub>	Power Efficiency	$V_{DD} = 15V$ $R_L = 2 k\Omega$	93	97	_	%
V <sub>DEF</sub>	Voltage Efficiency	$V_{DD} = 15V$ $R_L = \infty$	99	99.9	_	%
		Over Temperature Range	96	_		%
$V_Z$	Zener Voltage	$I_Z = 5mA$	6.0	6.2	6.4	V
Z <sub>ZT</sub>	Zener Impedance	$I_L = 2.5 \text{mA}$ to $7.5 \text{mA}$		12		Ω

#### **APPLICATIONS INFORMATION**

## Theory of Operation

The TC962 is a capacitive pump (sometimes called a switched capacitor circuit), where four MOSFET switches control the charge and discharge of a capacitor.

The functional diagram (page 1) shows how the switching action works. SW1 and SW2 are turned on simultaneously, charging  $C_P$  to the supply voltage,  $V_{IN}$ . This assumes that the on resistance of the MOSFETs in series with the capacitor results in a charging time (3 time constants) that is less than the on time provided by the oscillator frequency as shown:

$$3 (R_{DS(ON)} C_P) < C_P/(0.5 f_{OSC})$$

In the next cycle, SW1 and SW2 are turned off and after a very short interval of all switches being off (this prevents large currents from occurring due to cross conduction), SW3 and SW4 are turned on. The charge in  $C_P$  is then transferred to  $C_R$ , BUT WITH THE POLARITY INVERTED. In this way, a negative voltage is now derived.

Page 1 shows a functional diagram of the TC962. An oscillator supplies pulses to a flip-flop that is then fed to a set of level shifters. These level shifters then drive each set of switches at one-half the oscillator frequency.

The oscillator has two pins that control the frequency of oscillation. Pin 7 can have a capacitor added that is returned to ground. This will lower the frequency of the oscillator by adding capacitance to the timing capacitor internal to the TC962. Grounding pin 6 will turn on a current source and double the frequency. This will double the charge current going into the internal capacitor, as well as any capacitor added to pin 7.

A zener diode has been added to the TC962 for use as a reference in building external regulators. This zener runs from pin 1 to ground.

### **Capacitors**

In early charge pump converters, the capacitors were not considered critical due to the high  $R_{DS(ON)}$  of the MOSFET switches. In order to understand this, let's look at a model of a typical electrolytic capacitor (Figure 1).

Note that one of its characteristics is ESR (equivalent series resistance). This parasitic resistance winds up in series with the load. Thus, both voltage conversion efficiency and power conversion efficiency are compromised if a low ESR capacitor is not used.

In the test circuit, for example, just changing two capacitors,  $C_P$  and  $C_R$ , from capacitors with unspecified ESR to low ESR-type output, impedance changes from  $36\Omega$  to  $28\Omega,$  an improvement of 23%!

This applies to all types of capacitors, including film types (polyester, polycarbonate, etc.).

Some applications information suggest that the capacitor is not critical and attribute the limiting factor of the capacitor to its reactive value. Let's examine this:

$$X_C = \frac{1}{2\pi f C}$$
 and  $Z_C = \frac{X_C}{DS}$ ,

where DS (duty cycle) = 50%.

Thus,  $Z_C \approx 2.6\Omega$  at f = 12kHz, where C = 10 $\mu$ F.

For the TC962, f = 12,000 Hz, and a typical value of C would be  $10\mu F$ . This is a reactive impedance of  $\approx 2.6\Omega$ . If the ESR is as great as  $5\Omega$ , the reactive value is not as critical as it would first appear, as the ESR would predominate. The  $5\Omega$  value is typical of a general-purpose electrolytic capacitor.

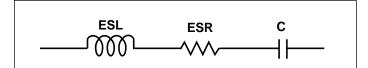
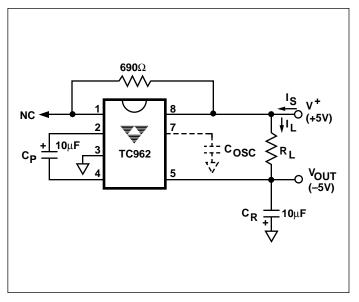


Figure 1. Typical Electrolytic Capacitor

## Latch Up

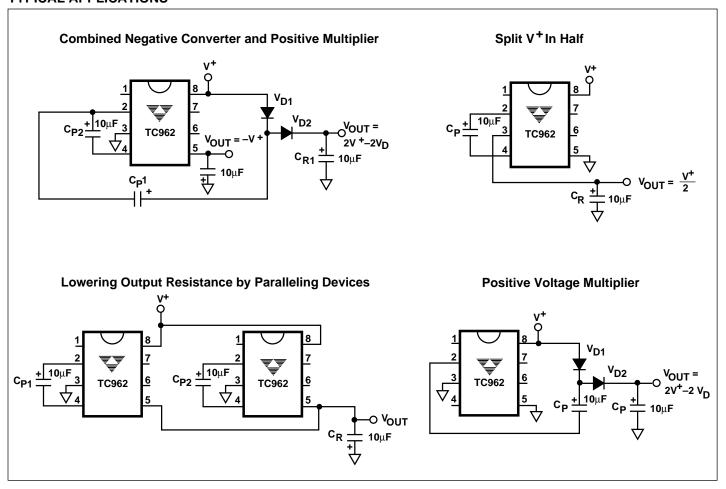
All CMOS structures contain a parasitic SCR. Care must be taken to prevent any input from going above or below the supply rail, or latch up will occur. The result of latch up is an effective short between  $V_{DD}$  and  $V_{SS}$ . Unless the power supply input has a current limit, this latch-up phenomena will result in damage to the device. (See Application Note 31 for additional information.)

#### **TEST CIRCUIT**

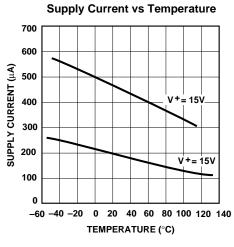


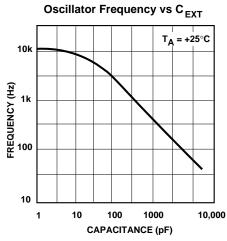
# **TC962**

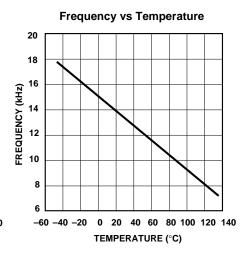
## **TYPICAL APPLICATIONS**

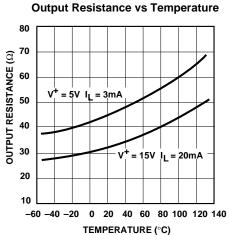


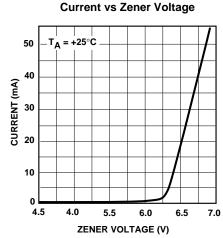
### TYPICAL CHARACTERISTICS

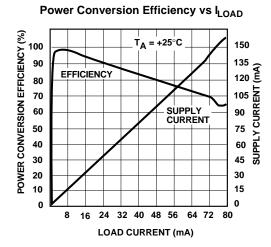


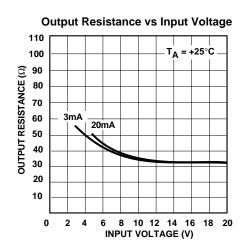






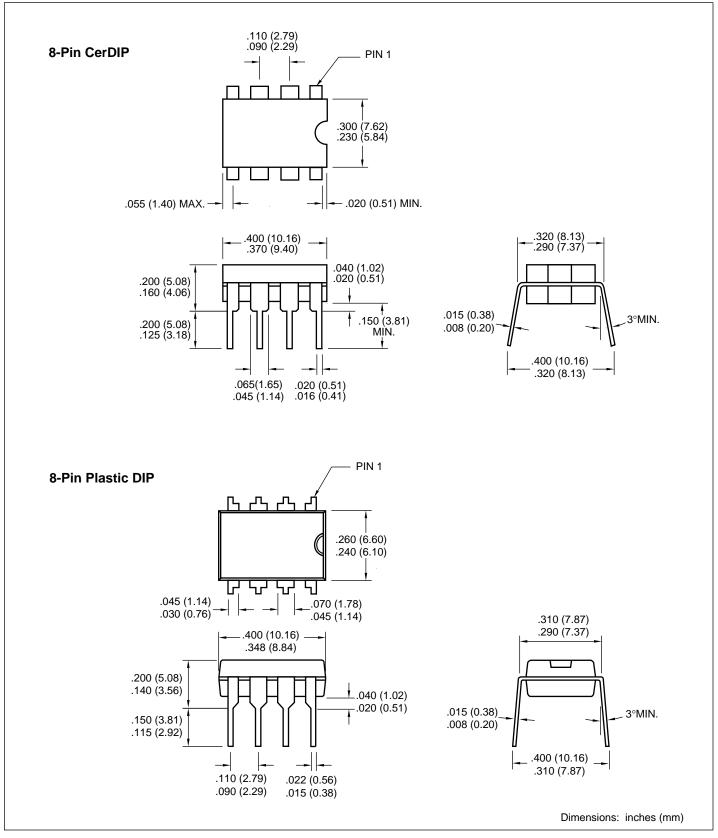




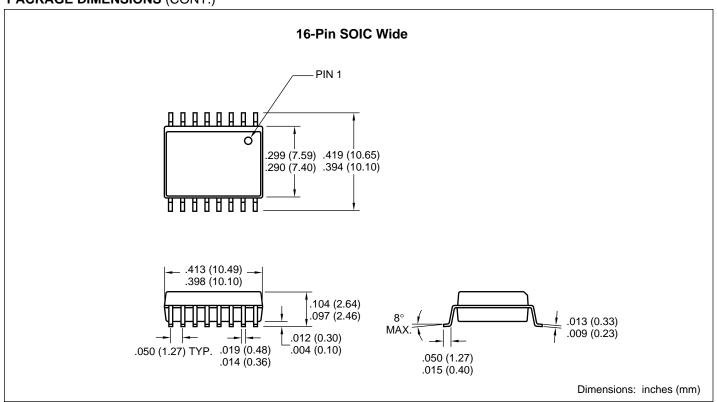


# **TC962**

### **PACKAGE DIMENSIONS**



### **PACKAGE DIMENSIONS (CONT.)**



### **Sales Offices**

TelCom Semiconductor 1300 Terra Bella Avenue P.O. Box 7267 Mountain View, CA 94039-7267 TEL: 415-968-9241 FAX: 415-967-1590

FAX: 415-967-1590 E-Mail: liter@telcom-semi.com **TelCom Semiconductor**Austin Product Center
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TEL: 852-2324-0122 FAX: 852-2354-9957